

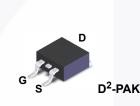
# FQB8N90C N-Channel QFET<sup>®</sup> MOSFET 900 V, 6.3 A, 1.9 Ω

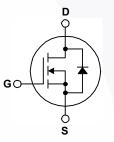
### Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies.

### Features

- 6.3 A, 900 V,  $R_{DS(on)}$  = 1.9  $\Omega$  (Max.) @  $V_{GS}$  = 10 V
- Low Gate Charge (Typ. 35 nC)
- Low C<sub>rss</sub> (Typ. 12 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQB8N90CTM	Unit	
V <sub>DSS</sub>	Drain-Source Voltage	900	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)	6.3	A	
	- Continuous (T <sub>C</sub> = 100°C)	3.8	А	
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	25	Α	
V <sub>GSS</sub>	Gate-Source Voltage	± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	850	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)	6.3	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	17.1	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.0	V/ns	
PD	Power Dissipation (T <sub>C</sub> = 25°C)	171	W	
	- Derate Above 25°C	1.37	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.	300	°C	

# **Thermal Characteristics**

Symbol	Parameter	FQB8N90CTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.73	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient, Max.	40	C/VV

December 2013

Ţ
Ð
Ω
8
ž
ĕ
ō
Ϋ́
7
~
<b>n</b>
Σ
ar
Ę
ē
<u> </u>
Ø
Ĩ
щ
٦
Σ
0
S
<u> </u>
щ
-

Part NumberTop MarkFQB8N90CTMFQB8N90C		Top Mark	Package	Packing Method	Reel Size	Tape Width 24 mm		n Qu	Quantity	
		FQB8N90C	D <sup>2</sup> -PAK	Tape and Reel	330 mm			800 untis		
lootrid		aractoristics								
Symbol		aracteristics Parameter	T <sub>C</sub> = 25°C unless o	Test Condi	tions	Min.	Тур.	Max.	Uni	
	vo otovi.	-41								
Off Cha				1/1 = 0.1/1 = 250.00	٨	000		1	V	
BV <sub>DSS</sub>	Drain-Se	ource Breakdown Volta	ge	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		900			V	
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		re Coefficient	$I_D = 250 \ \mu A$ , Referenced to $25^{\circ}C$			0.95		V/°(	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			$V_{\rm DS}$ = 900 V, $V_{\rm GS}$ = 0				10	μA	
	2010 00	te voltage Brain ourie		V <sub>DS</sub> = 720 V, T <sub>C</sub> = 12				100	μA	
I <sub>GSSF</sub>	Gate-Bo	ody Leakage Current, F	orward	$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				100	nA	
I <sub>GSSR</sub>	Gate-Bo	ody Leakage Current, R	leverse	$V_{GS}$ = -30 V, $V_{DS}$ = 0	V			-100	nA	
	haracteristics		_	$V_{DS} = V_{GS}, I_{D} = 250$		2.0		5.0	V	
V <sub>GS(th)</sub>				$v_{\rm DS} = v_{\rm GS}, r_{\rm D} = 230$	uA	3.0		5.0	v	
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.15	А		1.6	1.9	Ω	
9 <sub>FS</sub>	Forward Transconductance		V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3.15	А		5.5		S		
D		to via ti a a								
-		acteristics		1			1600	2020	~	
C <sub>iss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance		$V_{DS} = 25 V, V_{GS} = 0 V,$			1600 130	2080 170	pF		
C <sub>oss</sub> C <sub>rss</sub>			f = 1.0 MHz			130	170	pF pF		
Orss	Reveise						12	15	pi	
Switchi	ng Cha	racteristics								
t <sub>d(on)</sub>	Turn-On Delay Time			V <sub>DD</sub> = 450 V, I <sub>D</sub> = 8 A,			40	90	ns	
t <sub>r</sub>	Turn-Or	n Rise Time		$V_{\rm GS}$ = 10 V, R <sub>G</sub> = 25 $\Omega$ (Note 4)			110	230	ns	
t <sub>d(off)</sub>	Turn-Of	f Delay Time					70	150	ns	
t <sub>f</sub>	Turn-Of	f Fall Time					70	150	ns	
Qg	Total Ga	Total Gate Charge Gate-Source Charge		$V_{DS}$ = 720 V, I <sub>D</sub> = 8 A, V <sub>GS</sub> = 10 V		35	45	nC		
Q <sub>gs</sub>	Gate-Sc					10		nC		
Q <sub>gd</sub>	Gate-Drain Charge			(Note 4)		14		nC		
		Diode Characteris	tice and Mr	vimum Patingo						
l <sub>s</sub>				•				6.3	A	
's I <sub>SM</sub>	Maximum Continuous Drain-Source Diode Fo Maximum Pulsed Drain-Source Diode Forwar							25	A	
V <sub>SD</sub>		ource Diode Forward V		$V_{GS} = 0 V, I_S = 6.3 A$				1.4	A V	
vsD t <sub>rr</sub>		Recovery Time	onaye	$V_{GS} = 0 V, I_S = 0.5 A$ $V_{GS} = 0 V, I_S = 8 A,$			530		-	
		Percevery Time		$v_{GS} = 0 v, i_S = 0 A,$		-	530		ns	

Q<sub>rr</sub> Notes:

1. Repetitive rating : pulse-width limited by maximum junction temperature.

2. L = 40 mH, I<sub>AS</sub> = 6.3 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C. 3. I<sub>SD</sub> ≤ 8 A, di/dt ≤ 200 A/µs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, starting T<sub>J</sub> = 25°C. 4. Essentially independent of operating temperature.

Reverse Recovery Charge

2

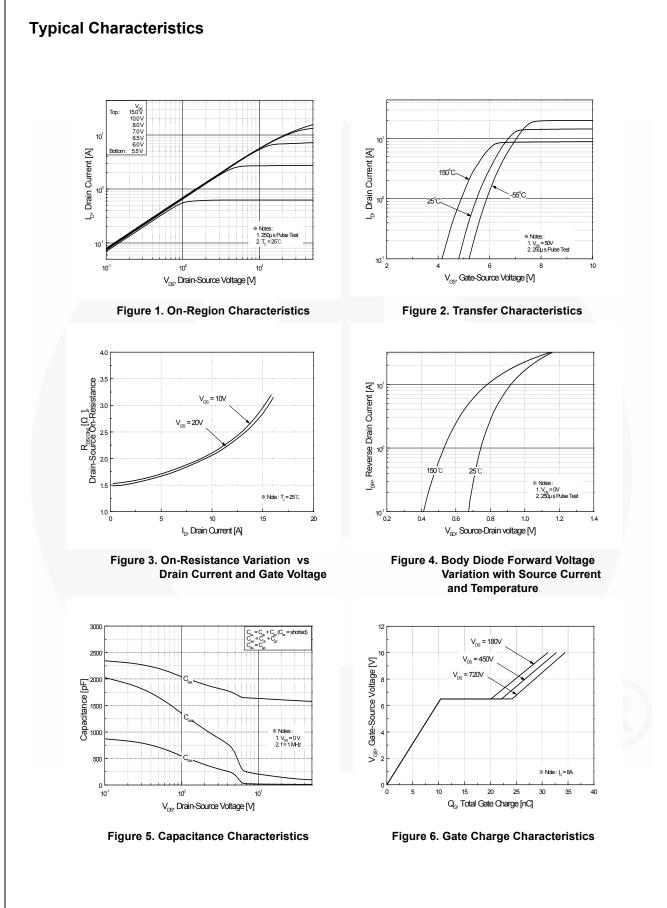
 $dI_F / dt = 100 A/\mu s$ 

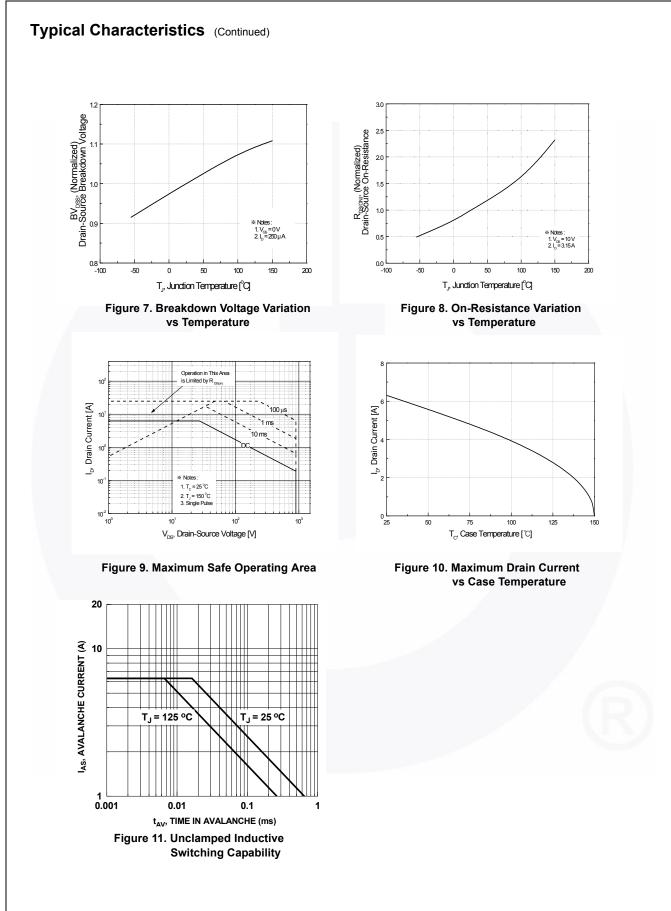
5.8

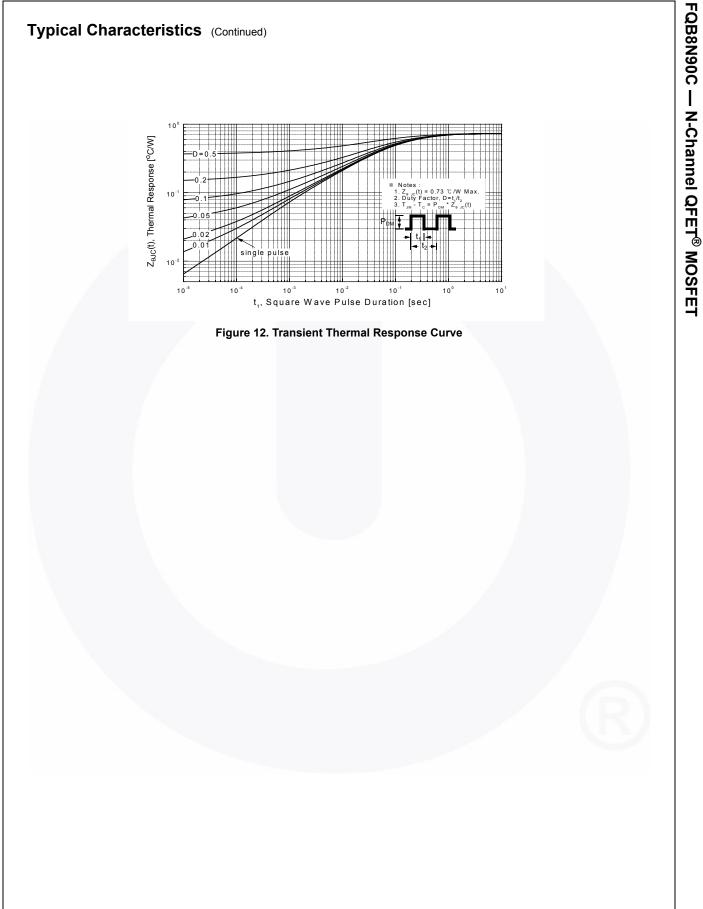
--

---

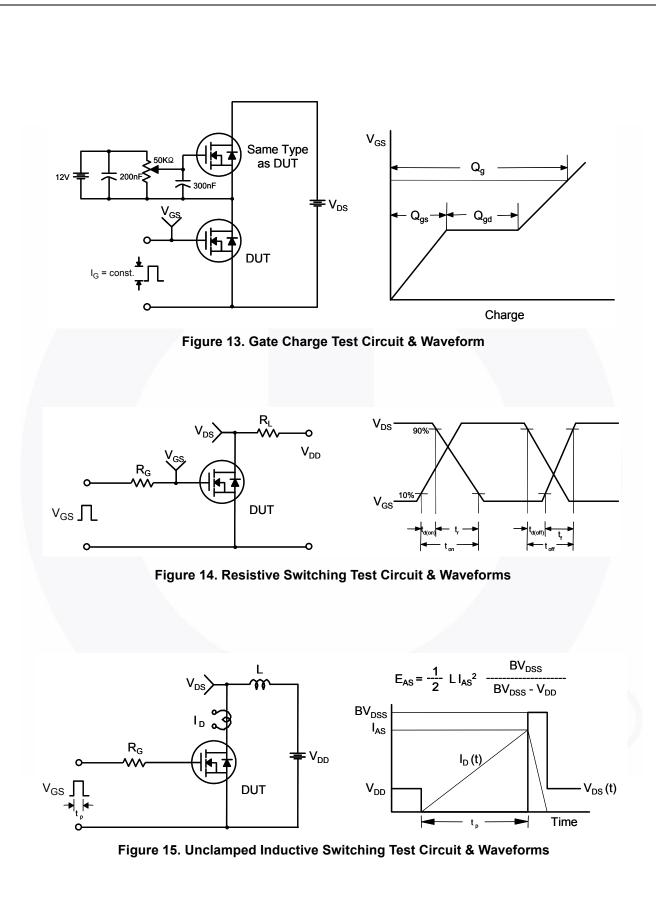
μC





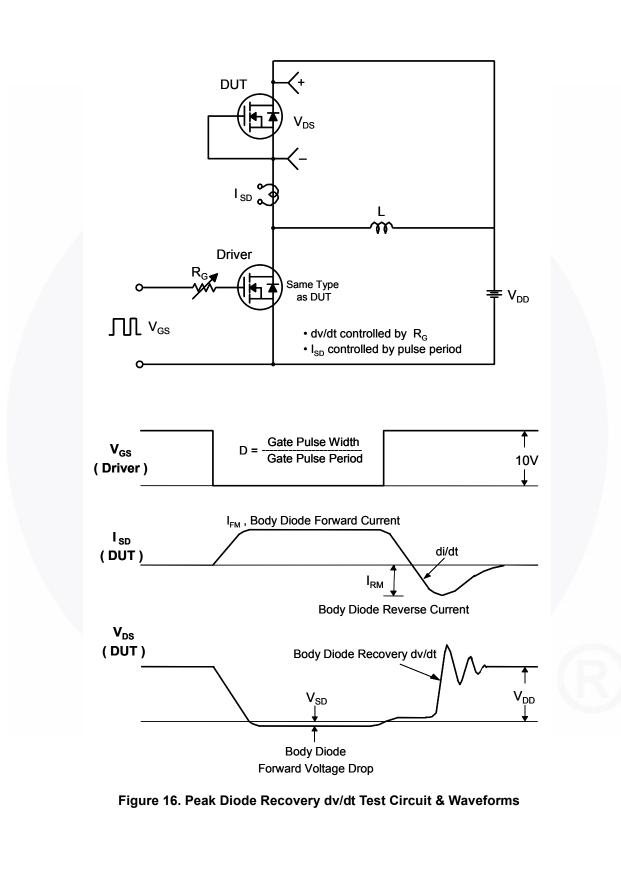


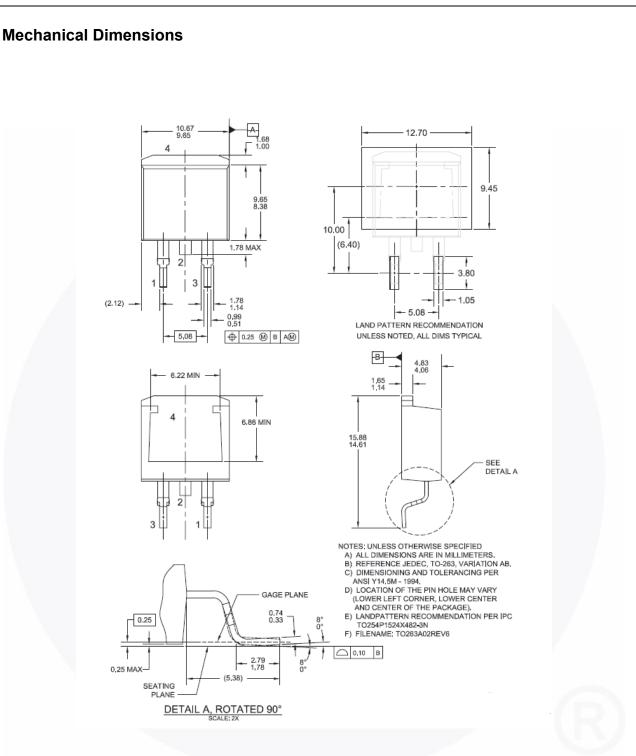
5



FQB8N90C — N-Channel QFET<sup>®</sup> MOSFET

FQB8N90C — N-Channel QFET<sup>®</sup> MOSFET





# Figure 17. TO263 (D<sup>2</sup>PAK), Molded, 2-Lead, Surface Mount

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/package/packageDetails.html?id=PN\_TT263-002

FQB8N90C — N-Channel QFET<sup>®</sup> MOSFET



SEMICONDUCTOR

#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

	an such trauemarks.		
AccuPower™ AccuPower™ AX-CAP®* BitSiC™ Build it Now™ CorePOWER™ CROSSVOLT™ CTL™ CUrrent Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK® EfficentMax™ ESBC™ Fairchild Semiconductor® FACT Quiet Series™ FACT®	F-PFS <sup>™</sup> FRFET <sup>®</sup> Global Power Resource <sup>SM</sup> Green FPS <sup>™</sup> Green FPS <sup>™</sup> e-Series <sup>™</sup> Gmax <sup>™</sup> GTO <sup>™</sup> IntelliMAX <sup>™</sup> ISOPLANAR <sup>™</sup> Marking Small Speakers Sound Lou and Better <sup>™</sup> MegaBuck <sup>™</sup> MiCroPak <sup>™</sup> Mic	Saving our world, 1mW/W/kW at a time™ SignalWise™ SMART START™ Solutions for Your Success™ SPM <sup>®</sup> STEALTH™ SuperFET <sup>®</sup> SuperSOT™-3 SuperSOT™-6	Sync-Lock <sup>™</sup> <b>EGENERAL</b> TinyBoost <sup>®</sup> TinyBuck <sup>®</sup> TinyDogic <sup>®</sup> TINYOPTO <sup>™</sup> TinyOPTO <sup>™</sup> TinyPWM <sup>™</sup> TinyPWM <sup>™</sup> TinyPWM <sup>™</sup> TinyWire <sup>™</sup> TriFault Detect <sup>™</sup> TRUECURRENT <sup>®</sup> * µSerDes <sup>™</sup> UHC <sup>®</sup> Ultra FRFET <sup>™</sup> UniFET <sup>™</sup>
Fairchild Semiconductor <sup>®</sup> FACT Quiet Series™	MotionMax™ mWSaver <sup>®</sup>	SuperFET <sup>®</sup> SuperSOT™-3	UHC <sup>®</sup> Ultra FRFET™

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### **PRODUCT STATUS DEFINITIONS** Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC